

Continued if Known

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**INFORMATION DISCLOSURE  
STATEMENT BY APPLICANT**

(use as many sheets as necessary)

Application Number	Not Assigned 10/500654
Confirmation Number	Not Assigned
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First Named Inventor	Michel PUECH
Art Unit	Not Assigned
Examiner Name	Not Assigned
Attorney Docket Number	Q82315

Sheet 1 of 1

**U.S. PATENT DOCUMENTS**

Examiner Initials*	Cite No. <sup>1</sup>	Document Number		Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document
		Number	Kind Code <sup>2</sup> (if known)		
		US 6,277,756	B1	08/21/2001	Denso Corporation
		US			
		US			
		US			
		US			
		US			
		US			
		US			

**FOREIGN PATENT DOCUMENTS**

Examiner Initials*	Cite No. <sup>1</sup>	Foreign Patent Document			Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Translation <sup>6</sup>
		Country Code <sup>3</sup>	Number <sup>4</sup>	Kind Code <sup>5</sup> (if known)			
		WO	00/05749		02/03/2000	Surface Technology Systems Ltd.	Yes
		DE	198 26 382	A1	12/16/1999	Robert Bosch GmbH	No
		JP	2000-200771		07/18/2000	Japan Science & Technology Corp.	Yes w/English Abstract
		JP	63-43321		02/24/1988	Matsushita Electric Ind Co. Ltd.	Yes w/English Abstract
		JP	8-17796		01/19/1996	Hitachi Ltd.	Yes w/English Abstract

**NON PATENT LITERATURE DOCUMENTS**

Examiner Initials*	Cite No. <sup>1</sup>	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city, and/or country where published.	Translation <sup>6</sup>
		A. A. Ayon et al, "Anisotropic Silicon Trenches 300-500 mum deep employing time multiplexed deep etching (TMDE)" SENSORS AND ACTUATORS A, Vol. 91, No. 3, July 15, 2001, pp. 381-385, XP004255492	Yes

Examiner Signature

Date Considered

\*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

<sup>1</sup> Applicant's unique citation designation number (optional). <sup>2</sup> See Kind Codes of USPTO Patent Documents at www.uspto.gov, MPEP 901.04 or in the comment box of this document. <sup>3</sup> Enter Office that issued the document, by the two-letter code (WIPO Standard ST. 3). <sup>4</sup> For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. <sup>5</sup> Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST. 16 if possible. <sup>6</sup> Applicant is to indicate here if English language Translation is attached.